

## 3.2 x 2.7 x 1.1mm Red & Yellow Green SMD

# **OSRG1206C1C**

#### **■Features**

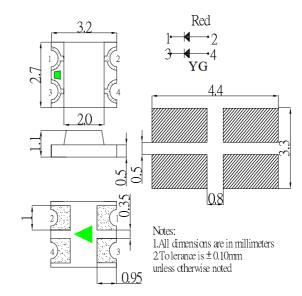
- · Bi-Color
- Super high brightness of surface mount LED
- Water Clear Flat Mold
- Compact package outline (LxWxT) of 3.2mm x 2.7mm x 1.1mm
- Compatible to IR reflow soldering.

# Applications

Backlighting (switches, keys, etc.)
Marker lights (e.g. steps, exit ways, etc.)

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#### **■Outline Dimension**

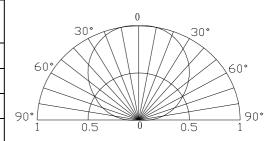


# ■Absolute Maximum Rating

# (Ta=25°C)

| Item                       | Cumbal            | Valı        | Unit                 |      |  |  |  |
|----------------------------|-------------------|-------------|----------------------|------|--|--|--|
| Item                       | Symbol            | HR          | YG                   | Omit |  |  |  |
| DC Forward Current         | $I_F$             | 20          | 20                   | mA   |  |  |  |
| Pulse Forward Current#     | $I_{\mathrm{FP}}$ | 100         | 100                  | mA   |  |  |  |
| Reverse Voltage            | $V_R$             | 5           | 5                    | V    |  |  |  |
| Power Dissipation          | $P_D$             | 48          | 48                   | mW   |  |  |  |
| Operating Temperature      | Topr              | -40 ~       | $^{\circ}\mathbb{C}$ |      |  |  |  |
| Storage Temperature        | Tstg              | -40~ +85    |                      |      |  |  |  |
| Lead Soldering Temperature | Tsol              | 260°C/10sec |                      |      |  |  |  |
|                            |                   |             |                      |      |  |  |  |

# **■**Directivity



#Pulse width Max 0.1ms, Duty ratio max 1/10

# **■**Electrical -Optical Characteristics

### (Ta=25°C)

|             |              |       |    | $V_{F}(V)$ |                   | $I_R(\mu A)$ | Iv(mcd)            |                      | λD(nm) |      |      | 2θ1/2(deg) |      |      |     |
|-------------|--------------|-------|----|------------|-------------------|--------------|--------------------|----------------------|--------|------|------|------------|------|------|-----|
|             | Part Number  | Color |    | Min.       | Тур.              | Max.         | Max.               | Min.                 | Тур.   | Max. | Min. | Тур.       | Max. | Тур. |     |
|             |              |       |    |            | $I_F=10mA$ $V_R=$ |              | V <sub>R</sub> =5V | I <sub>F</sub> =10mA |        |      |      |            |      |      |     |
|             | OSDC1206C1C  | Red   | HR |            | -                 | 1.8          | 2.4                | 10                   | 40     | 60   | -    | 620        | 625  | 630  | 120 |
| OSRG1206C1C | Yellow Green | YG    |    | -          | 1.8               | 2.4          | 10                 | 12                   | 25     | -    | 565  | 570        | 575  | 120  |     |

<sup>\*1</sup> Tolerance of measurements of dominant wavelength is ±1nm

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<sup>\*2</sup> Tolerance of measurements of luminous intensity is ±15%

<sup>\*3</sup> Tolerance of measurements of forward voltage is  $\pm 0.1$  V

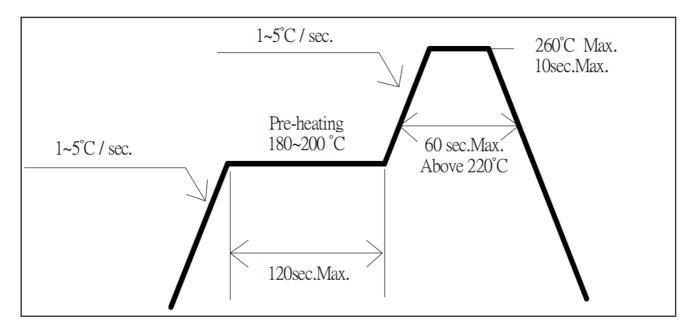


#### 3.2 x 2.7 x 1.1mm Red & Yellow Green SMD

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## **■** Soldering Conditions

|                  | Reflow Soldering             | Hand Soldering |                 |  |  |  |
|------------------|------------------------------|----------------|-----------------|--|--|--|
| Pre-Heat         | 180 ~ 200°C                  |                |                 |  |  |  |
| Pre-Heat Time    | 120 sec. Max.                |                | 350°C Max.      |  |  |  |
| Peak temperature | 260°C Max.                   | Temperature    |                 |  |  |  |
| Dipping Time     | 10 sec. Max.                 | Soldering time | 3 sec. Max.     |  |  |  |
| Condition        | Refer to Temperature-profile |                | (one time only) |  |  |  |



- \*Recommended soldering conditions vary according to the type of LED
- \*Although the recommended soldering conditions are specified in the above table, reflow, or hand soldering at the lowest possible temperature is desirable for the LEDs.
- \*A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- •All SMD LED products are pb-free soldering available.
- Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

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#### **■** Cautions:

- 1. After open the package, the LED's floor life is 4 Weeks under 30℃ or less and 60%RH or less(MSL:2a).
- 2. Heat generation must be taken into design consideration when using the LED.
- 3. Power must be applied resistors for protection, over current would be caused the optic damage to the devices and wavelength shift.
- 4. Manual tip solder may cause the damage to Chip devices, so advised that heat of iron should be lower than 15W with temperature control under 5 seconds at 230-260 deg. C. (The device would be got damage in re working process, recommended under 5 seconds at 230-260 deg. C)
- 5. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LED.
- 6. Use IPA as a solvent for cleaning the LED. The other solvent may dissolve the LED package and the epoxy, Ultrasonic cleaning should not be done.
- 7. Damaged LED will show unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LED get unlight at low current.

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